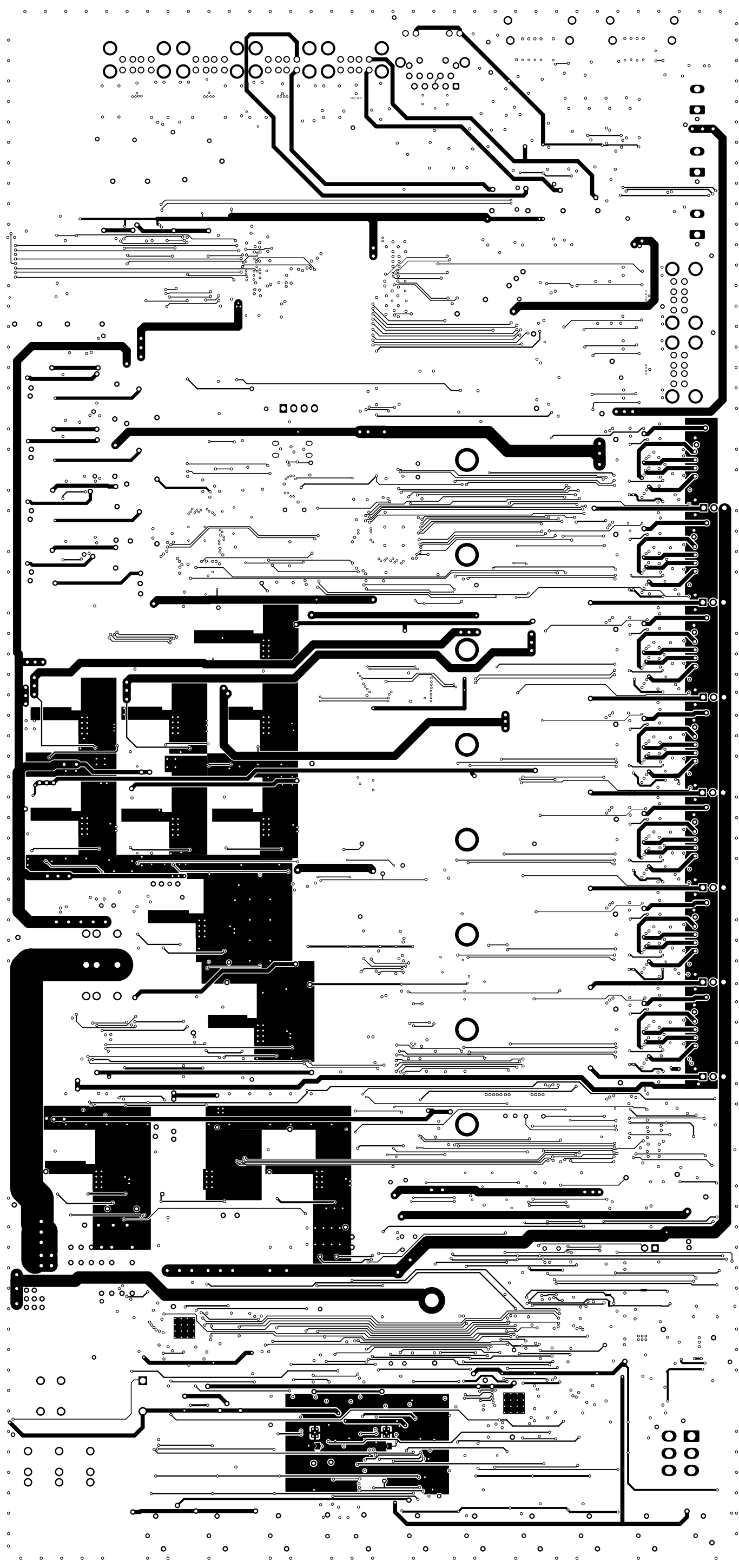
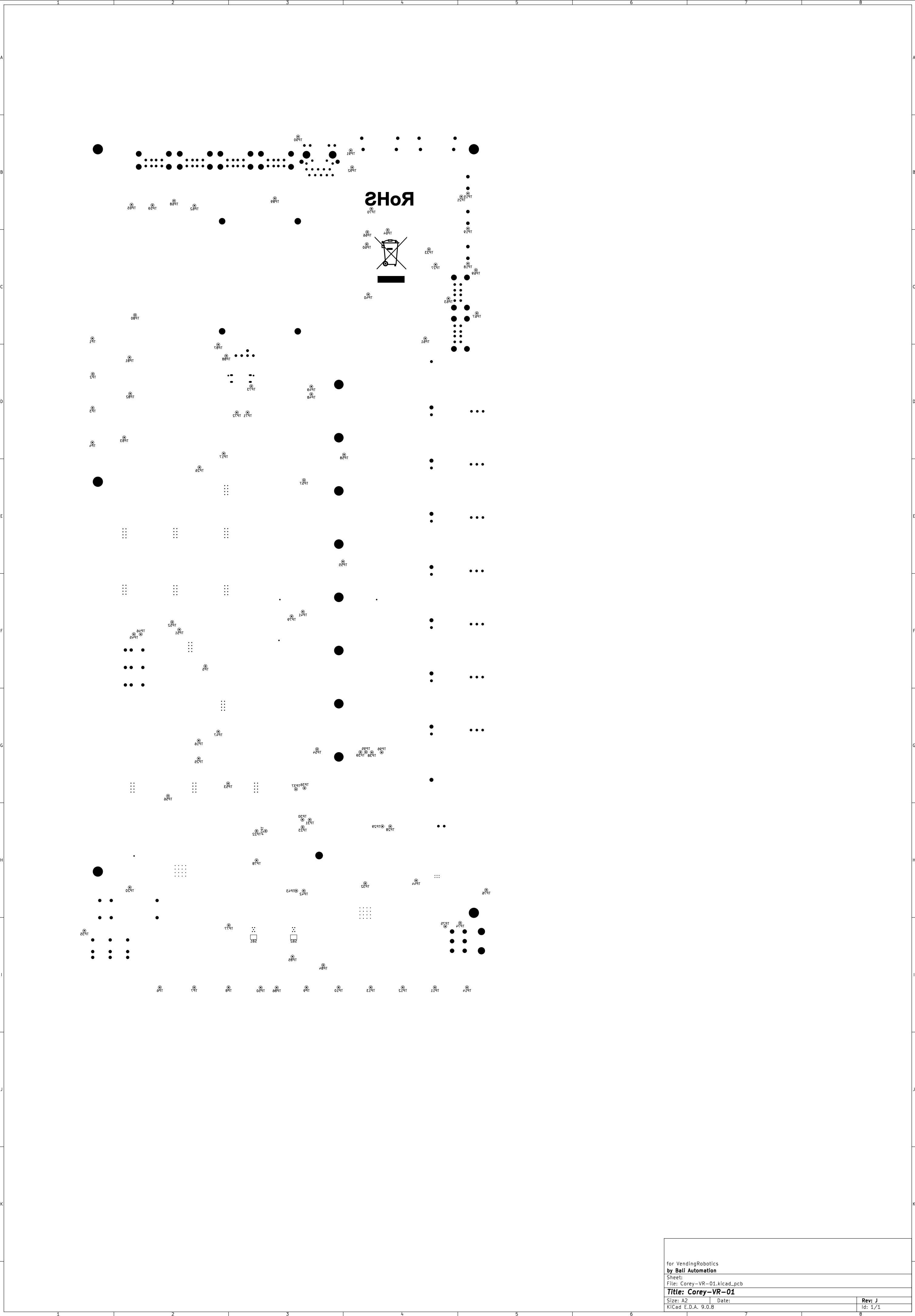
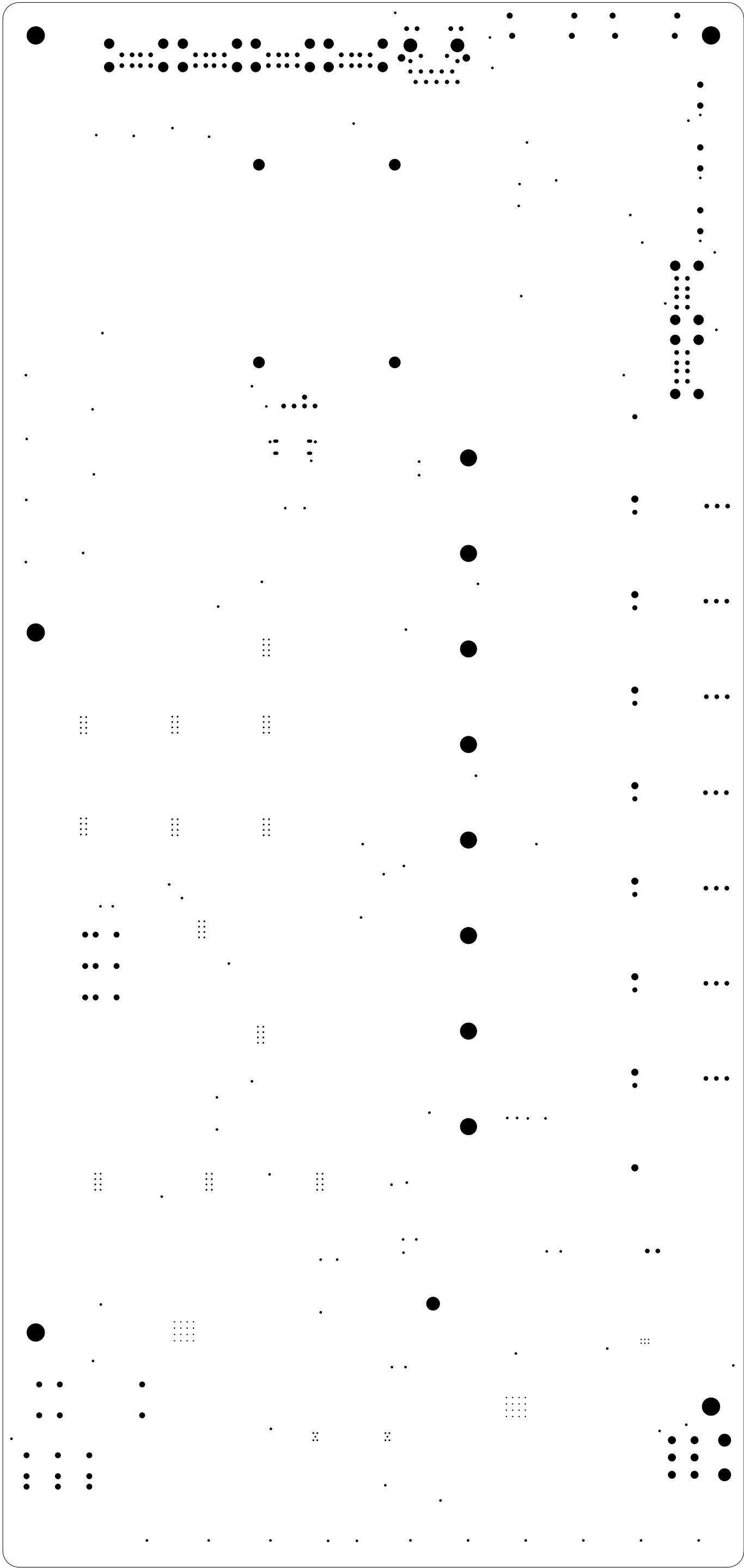
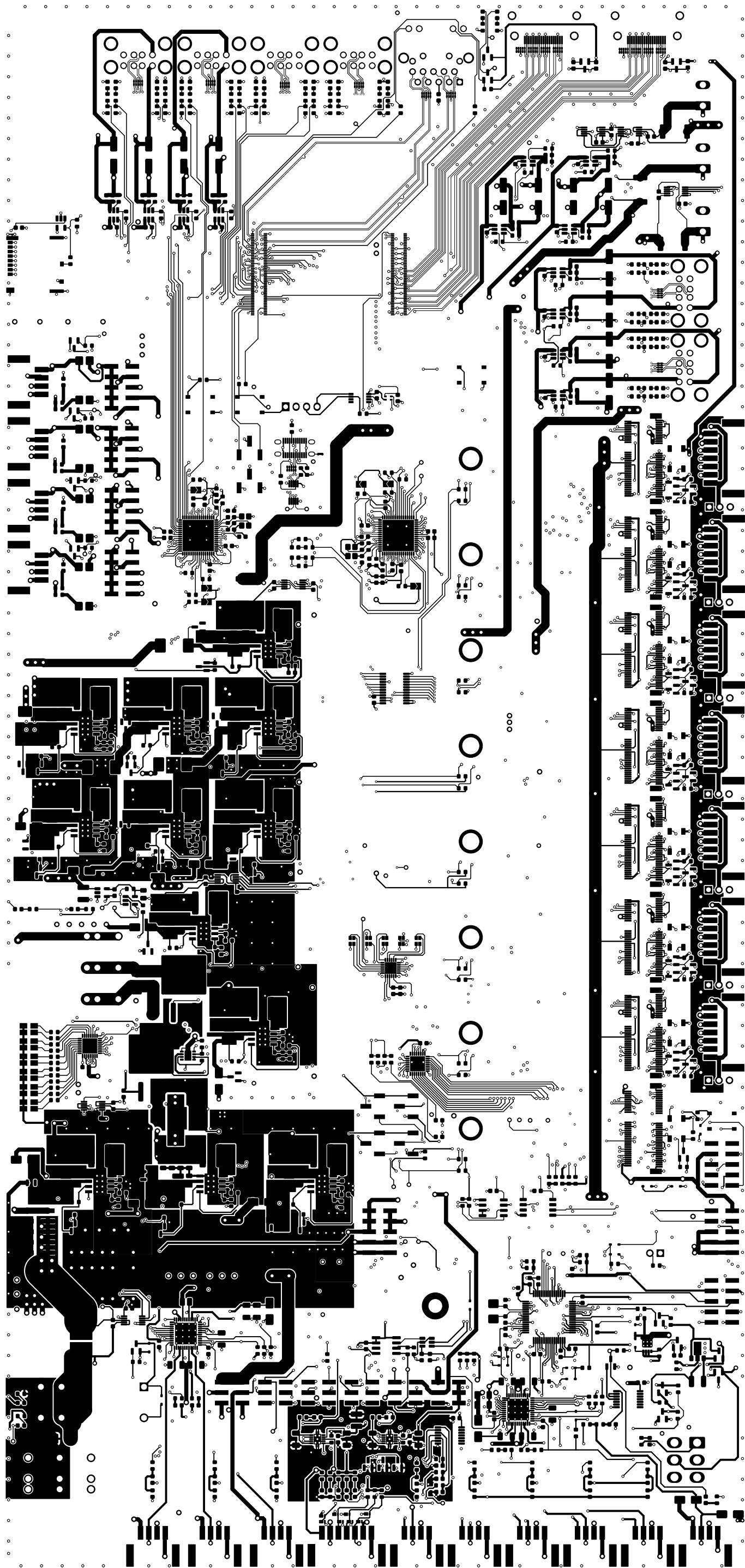










BOARD CHARACTERISTICS

Copper Layer Count: 6

Board Thickness: 1.5584 mm

Board overall dimensions: 180.0000 mm x 380.0000 mm

Min track/spacing: 0.0889 mm / 0.0889 mm

Min hole diameter: 0.2000 mm

Copper Finish: None

Impedance Control: Yes

Castellated pads: No

Plated Board Edge: No

Edge card connectors: No

Advanced PCB, 6 layers, matched impedance, JLCPCB type: JLC06161H-3313A

Layer Name	Type	Material	Thickness (mm)	Color	Epsilon R	Loss Tangent
F.Silkscreen	Top Silk Screen	Not specified	0 mm	White	1	0
F.Paste	Top Solder Paste	Not specified	0 mm		1	0
F.Mask	Top Solder Mask	Not specified	0.01 mm	Blue	3.3	0
F.Cu	copper		0.035 mm		1	0
Dielectric	prepreg	FR4	0.0994 mm	Not specified	4.5	0.02
In1.Cu	copper		0.0152 mm		1	0
Dielectric	core	FR4	0.55 mm	Not specified	4.5	0.02
In2.Cu	copper		0.0152 mm		1	0
Dielectric	prepreg	FR4	0.1088 mm	Not specified	4.5	0.02
In3.Cu	copper		0.0152 mm		1	0
Dielectric	core	FR4	0.55 mm	Not specified	4.5	0.02
In4.Cu	copper		0.0152 mm		1	0
Dielectric	prepreg	FR4	0.0994 mm	Not specified	4.5	0.02
B.Cu	copper		0.035 mm		1	0
B.Mask	Bottom Solder Mask	Not specified	0.01 mm	Blue	3.3	0
B.Paste	Bottom Solder Paste	Not specified	0 mm		1	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	White	1	0